# 74LVC2G07

## **Buffers with open-drain outputs**

Rev. 11 — 29 September 2021

**Product data sheet** 

## 1. General description

The 74LVC2G07 is a dual buffer with open-drain outputs. Inputs can be driven from either 3.3~V or 5~V devices. This feature allows the use of these devices as translators in mixed 3.3~V and 5~V environments.

Schmitt trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

## 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- · High noise immunity
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - JESD36 (4.5 V to 5.5 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- -24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power dissipation
- · Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



## **Buffers with open-drain outputs**

# 3. Ordering information

**Table 1. Ordering information** 

Type number	Package			
	Temperature range	Name	Description	Version
74LVC2G07GW	-40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363
74LVC2G07GV	-40 °C to +125 °C	SC-74; TSOP6	plastic surface-mounted package; 6 leads	SOT457
74LVC2G07GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74LVC2G07GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74LVC2G07GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202
74LVC2G07GX	-40 °C to +125 °C	X2SON6	plastic thermal enhanced extremely thin small outline package; no leads; 6 terminals; body 1.0 × 0.8 × 0.32 mm	SOT1255-2

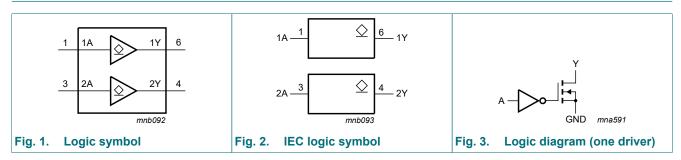
## 4. Marking

Table 2. Marking

Type number	Marking code[1]
74LVC2G07GW	V7
74LVC2G07GV	V07
74LVC2G07GM	V7
74LVC2G07GN	V7
74LVC2G07GS	V7
74LVC2G07GX	V7

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram



**Buffers with open-drain outputs** 

## 6. Pinning information

## 6.1. Pinning





## 6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
1A	1	data input
GND	2	ground (0 V)
2A	3	data input
2Y	4	data output
V <sub>CC</sub>	5	supply voltage
1Y	6	data output

## 7. Functional description

#### **Table 4. Function table**

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; Z = high-impedance OFF-state.}$ 

Input nA	Output nY
L	L
Н	Z

#### **Buffers with open-drain outputs**

## 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
V <sub>I</sub>	input voltage		[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V		-50	-	mA
Vo	output voltage	Active mode	[1]	-0.5	+6.5	V
		Power-down mode; V <sub>CC</sub> = 0 V	[1]	-0.5	+6.5	V
Io	output current	V <sub>O</sub> = 0 V to 6.5 V		-	50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	250	mW

<sup>[1]</sup> The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT457 (SC-74; TSOP6) package: Ptot derates linearly with 4.1 mW/K above 89 °C.

For SOT886 (XSON6) package: Ptot derates linearly with 3.3 mW/K above 74 °C.

For SOT1115 (XSON6) package:  $P_{tot}$  derates linearly with 3.2 mW/K above 71 °C.

For SOT1202 (XSON6) package: Ptot derates linearly with 3.3 mW/K above 74 °C.

For SOT1255-2 (X2SON6) package: Ptot derates linearly with 3.3 mW/K above 75 °C.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	5.5	V
V <sub>I</sub>	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	5.5	V
		Power-down mode; V <sub>CC</sub> = 0 V	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and	V <sub>CC</sub> = 1.65 V to 2.7 V	-	-	20	ns/V
	fall rate	V <sub>CC</sub> = 2.7 V to 5.5 V	-	-	10	ns/V

<sup>[2]</sup> For SOT363 (SC-88) package: Ptot derates linearly with 3.7 mW/K above 83 °C.

## **Buffers with open-drain outputs**

## 10. Static characteristics

#### **Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +85 °C [1]					
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 x V <sub>CC</sub>	-	-	V
	voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7 x V <sub>CC</sub>	-	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35 x V <sub>CC</sub>	V
	voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.3 x V <sub>CC</sub>	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	-	-	0.10	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.30	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.40	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	V
		I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V	-	-	0.55	V
Iį	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V [2]	-	±0.1	±1	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	±0.1	±2	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 5.5 \text{ V}$ ; $V_{CC} = 0 \text{ V}$	-	±0.1	±2	μΑ
I <sub>CC</sub>	supply current	V <sub>I</sub> = 5.5 V or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 1.65 V to 5.5 V	-	0.1	4	μΑ
Δl <sub>CC</sub>	additional supply current	per pin; $V_1 = V_{CC} - 0.6 \text{ V}$ ; $I_0 = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	5	500	μΑ
Cı	input capacitance		-	2.5	-	рF

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +125 °C					
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 x V <sub>CC</sub>	-	-	V
V	voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7 x V <sub>CC</sub>	-	-	V
V <sub>IL</sub>		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35 x V <sub>CC</sub>	V
voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V	
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.3 x V <sub>CC</sub>	V
V <sub>OL</sub> LOW-level output	· ·	$V_I = V_{IH}$ or $V_{IL}$				
	voltage	$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.70	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.45	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.60	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.80	V
		I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V	-	-	0.80	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	±1	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±2	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 5.5 \text{ V}$ ; $V_{CC} = 0 \text{ V}$	-	-	±2	μΑ
I <sub>CC</sub>	supply current	V <sub>I</sub> = 5.5 V or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 1.65 V to 5.5 V	-	-	4	μΑ
ΔI <sub>CC</sub>	additional supply current	per pin; $V_1 = V_{CC}$ - 0.6 V; $I_0 = 0$ A; $V_{CC} = 2.3$ V to 5.5 V	-	-	500	μΑ

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C. [2] These typical values are measured at  $V_{CC}$  = 3.3 V.

#### **Buffers with open-drain outputs**

## 11. Dynamic characteristics

#### **Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions	-40	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA to nY; see Fig. 8 [2]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.0	3.5	6.7	1.0	8.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.5	2.4	4.3	0.5	5.5	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.3	4.2	1.0	5.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.5	2.6	3.7	0.5	4.7	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.5	1.5	2.9	0.5	3.7	ns
C <sub>PD</sub>	power dissipation capacitance	$V_{I} = GND \text{ to } V_{CC}; V_{CC} = 3.3 \text{ V } [3]$	-	6.5	-	-	-	pF

- Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.
- $t_{pd}$  is the same as  $t_{PLZ}$  and  $t_{PZL}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

 $f_o$  = output frequency in MHz;

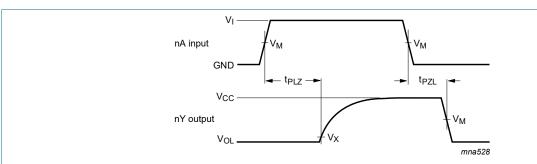
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

### 11.1. Waveform and test circuit



Measurement points are given in Table 9.

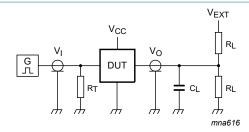
V<sub>OL</sub> is the typical output voltage level that occur with the output load.

The input (nA) to output (nY) propagation delays

**Table 9. Measurement points** 

Supply voltage	Input	Output	Output		
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>		
1.65 V to 1.95 V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V		
2.3 V to 2.7 V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V		
2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V		
3.0 V to 3.6 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V		
4.5 V to 5.5 V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V		

## **Buffers with open-drain outputs**



Test data is given in Table 10.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $\ensuremath{C_L}$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

## Fig. 9. Test circuit for measuring switching times

#### Table 10. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	1 kΩ	2 x V <sub>CC</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	2 x V <sub>CC</sub>
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	6 V
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	6 V
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	2 x V <sub>CC</sub>

### **Buffers with open-drain outputs**

# 12. Package outline

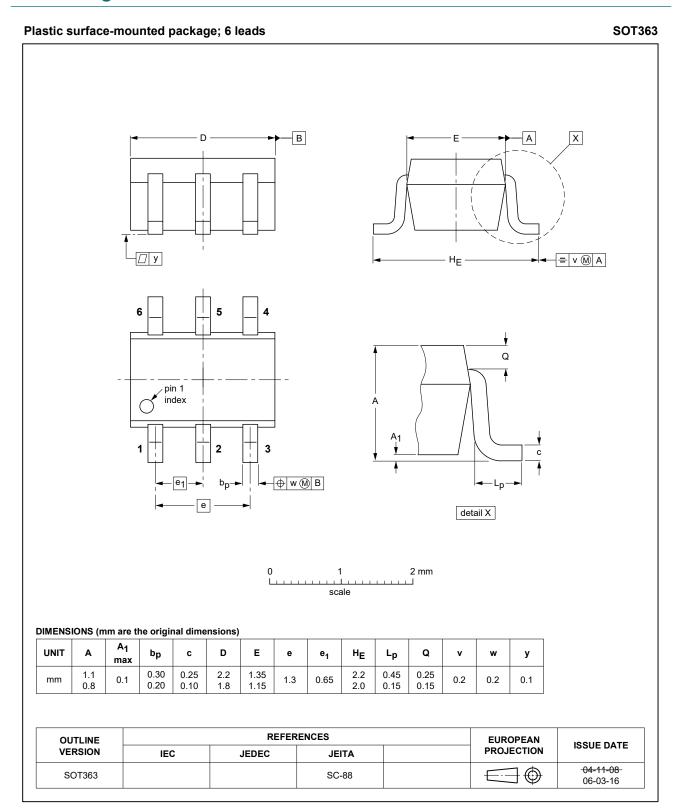


Fig. 10. Package outline SOT363 (SC-88)

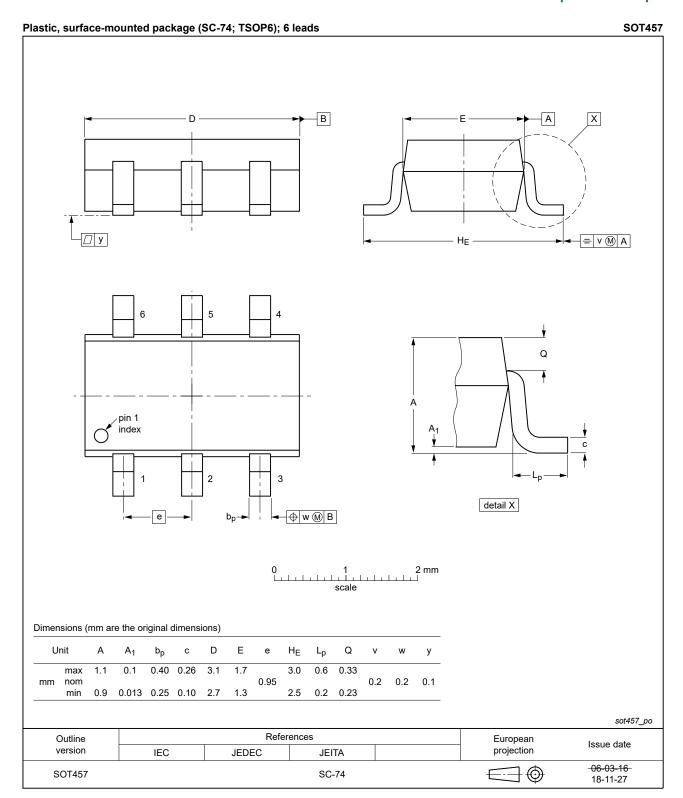


Fig. 11. Package outline SOT457 (SC-74; TSOP6)

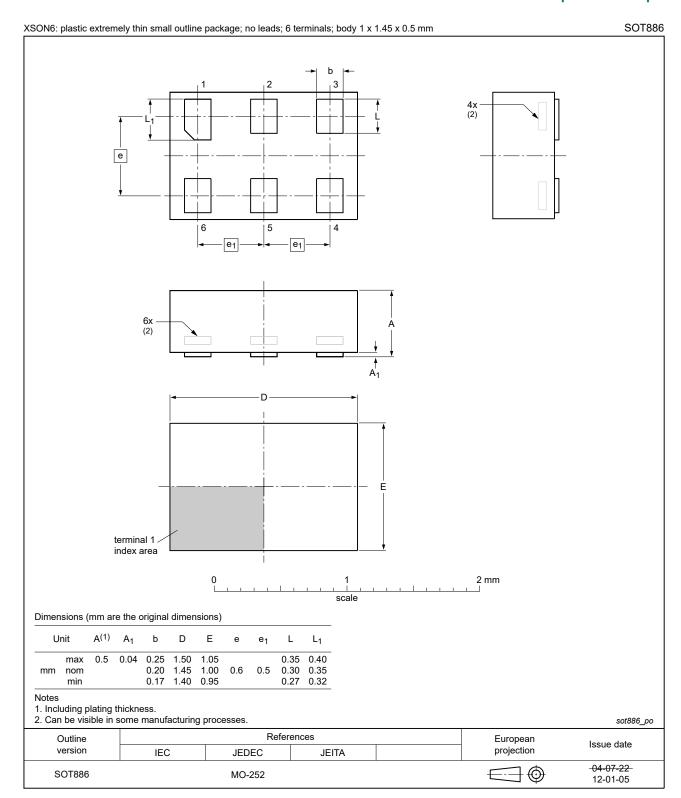


Fig. 12. Package outline SOT886 (XSON6)

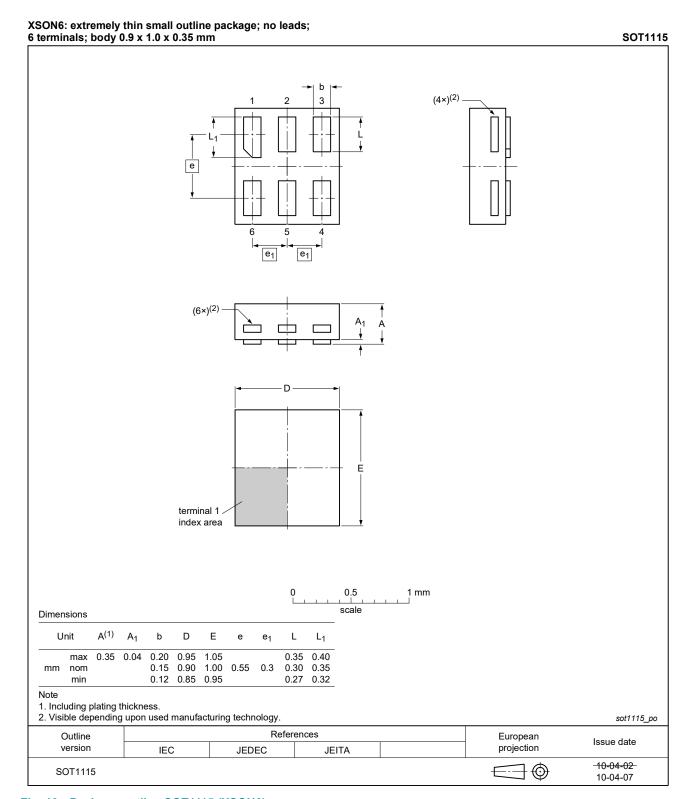


Fig. 13. Package outline SOT1115 (XSON6)

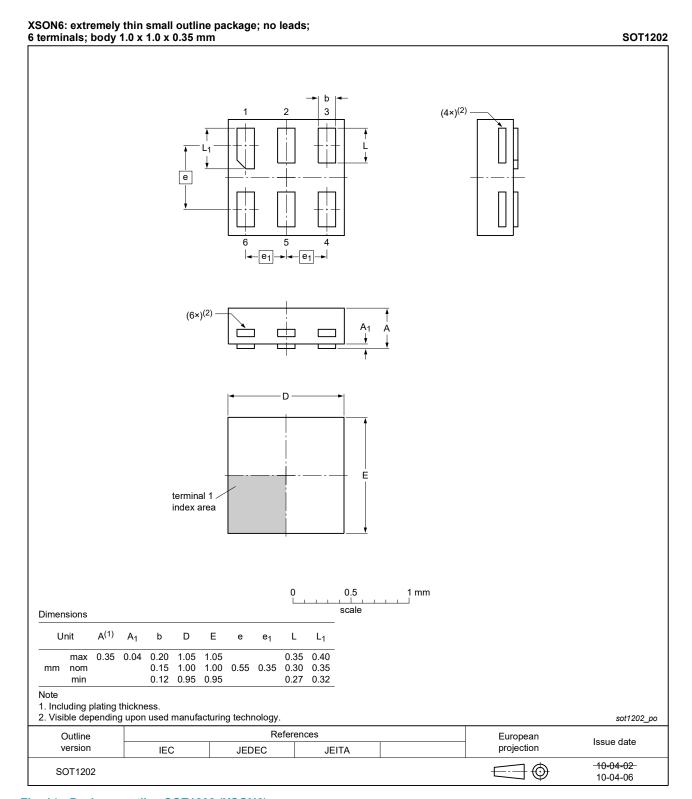


Fig. 14. Package outline SOT1202 (XSON6)

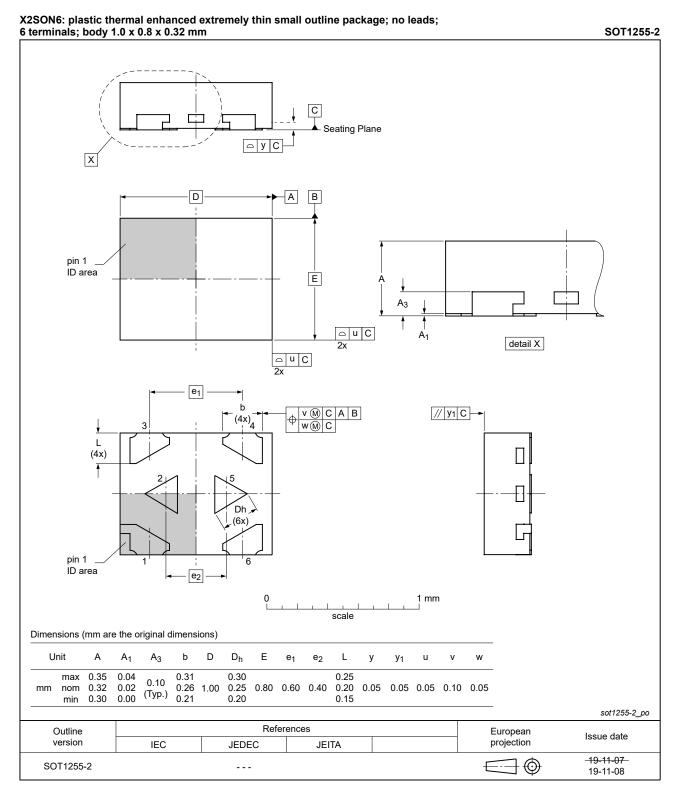


Fig. 15. Package outline SOT1255-2 (X2SON6)

## **Buffers with open-drain outputs**

## 13. Abbreviations

#### **Table 11. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

## Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2G07 v.11	20210929	Product data sheet	-	74LVC2G07 v.10
Modifications:	<ul> <li>SOT1255 (X2</li> <li><u>Table 5</u>: Dera</li> <li><u>Fig. 11</u>: Packa</li> </ul>	74LVC2G07GF (SOT891/XSC 2SON6) package changed to S ting values for P <sub>tot</sub> total power age outline drawing SOT457 u I <u>Section 2</u> updated.	OT1255-2 (X2SON dissipation updated	<i>,</i> . •
74LVC2G07 v.10	20170821	Product data sheet	-	74LVC2G07 v.9
Modifications:	Nexperia.	this data sheet has been rede ave been adapted to the new c		
74LVC2G07 v.9	20161212	Product data sheet	-	74LVC2G07 v.8
Modifications:	• <u>Table 7</u> : The	maximum limits for leakage cu	rrent and supply cu	rrent have changed.
74LVC2G07 v.8	20150923	Product data sheet	-	74LVC2G07 v.7
Modifications:	Added type n	umber 74LVC2G07GX (SOT1	255/X2SON6).	
74LVC2G07 v.7	20120704	Product data sheet	-	74LVC2G07 v.6
Modifications:	Package outli	ne drawing of SOT886 (Fig. 1	2) modified.	
74LVC2G07 v.6	20111130	Product data sheet	-	74LVC2G07 v.5
Modifications:	Legal pages i	updated.		
74LVC2G07 v.5	20100806	Product data sheet	-	74LVC2G07 v.4
74LVC2G07 v.4	20070521	Product data sheet	-	74LVC2G07 v.3
74LVC2G07 v.3	20040908	Product data sheet	-	74LVC2G07 v.2
74LVC2G07 v.2	20040319	Product data sheet	-	74LVC2G07 v.1
74LVC2G07 v.1	20030825	Product data sheet	-	-

### **Buffers with open-drain outputs**

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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## **Buffers with open-drain outputs**

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